

# 35.0-45.0 GHz GaAs MMIC Buffer Amplifier

March 2007 - Rev 06-Mar-07

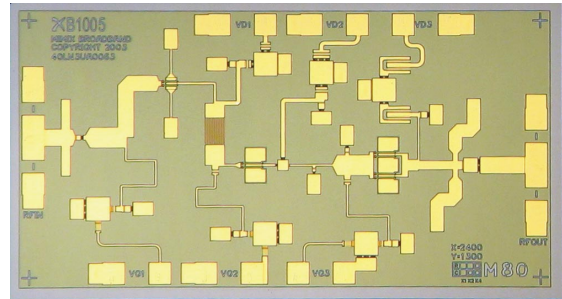
## Features

- ✕ High Dynamic Range
- ✕ Excellent LO Driver/Buffer Amplifier
- ✕ Low Noise or Power Bias Configurations
- ✕ 23.0 dB Small Signal Gain
- ✕ 2.7 dB Noise Figure at Low Noise Bias
- ✕ +16 dBm P1dB Compression at Power Bias
- ✕ 100% On-Wafer RF, DC and Noise Figure Testing
- ✕ 100% Visual Inspection to MIL-STD-883 Method 2010

## General Description

Mimix Broadband's three stage 35.0-45.0 GHz GaAs MMIC buffer amplifier has a small signal gain of 23.0 dB with a noise figure of 2.7 dB across the band. This MMIC uses Mimix Broadband's 0.15  $\mu\text{m}$  GaAs PHEMT device model technology, and is based upon electron beam lithography to ensure high repeatability and uniformity. The chip has surface passivation to protect and provide a rugged part with backside via holes and gold metallization to allow either a conductive epoxy or eutectic solder die attach process. This device is well suited for Millimeter-wave Point-to-Point Radio, SATCOM and VSAT applications.

## Chip Device Layout



## Absolute Maximum Ratings

Supply Voltage (Vd)	+6.0 VDC
Supply Current (Id)	180 mA
Gate Bias Voltage (Vg)	+0.3 VDC
Input Power (Pin)	+5 dBm
Storage Temperature (Tstg)	-65 to +165 °C
Operating Temperature (Ta)	-55 to MTTF Table <sup>5</sup>
Channel Temperature (Tch)	MTTF Table <sup>5</sup>

(5) Channel temperature affects a device's MTBF. It is recommended to keep channel temperature as low as possible for maximum life.

## Electrical Characteristics (Ambient Temperature T = 25 °C)

Parameter	Units	Min.	Typ.	Max.
Frequency Range (f)	GHz	35.0	-	45.0
Input Return Loss (S11) <sup>3</sup>	dB	4.0	8.0	-
Output Return Loss (S22) <sup>3</sup>	dB	9.0	17.0	-
Small Signal Gain (S21) <sup>3</sup>	dB	20.0	23.0	27.0
Gain Flatness ( $\Delta S21$ )	dB	-	+/-1.0	-
Reverse Isolation (S12) <sup>3</sup>	dB	35.0	45.0	-
Noise Figure (NF) <sup>4</sup>	dB	-	2.7	3.5
Output Power for 1 dB Compression (P1dB) <sup>1,2,3</sup>	dBm	-	+16.0	-
Output Third Order Intercept Point (OIP3) <sup>1,2,3</sup>	dBm	-	+26.0	-
Saturated Output Power (Psat) <sup>1,2,3</sup>	dBm	+16.0	+18.0	-
Drain Bias Voltage (Vd1,2,3)	VDC	-1.2	+3.5	+4.5
Gate Bias Voltage (Vg1,2,3)	VDC	-	-0.4	+0.1
Supply Current (Id) (Vd=3.5V, Vg=-0.4V Typical)	mA		50	154

(1) Optional low noise bias Vd1,2,3=3.5V, Id=50mA will typically yield 3-4dB decreased P1dB and OIP3.

(2) Measured using constant current.

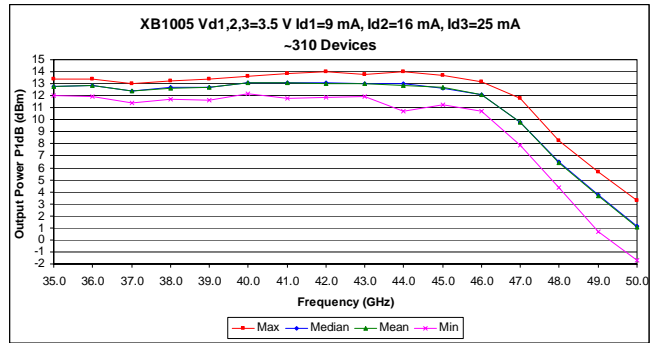
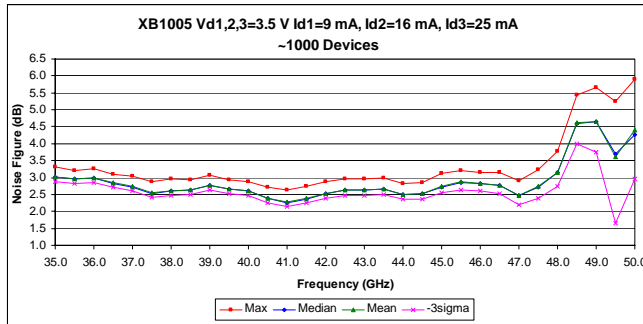
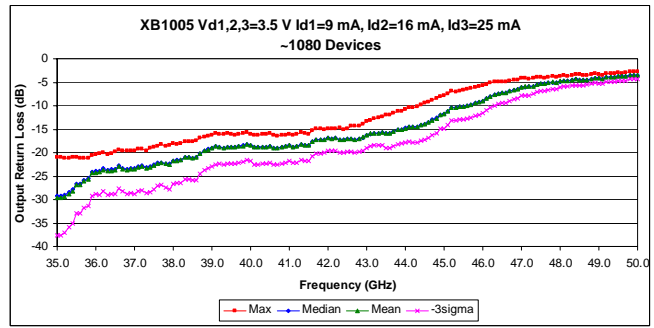
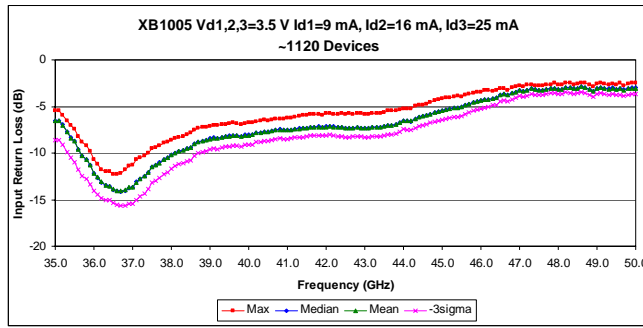
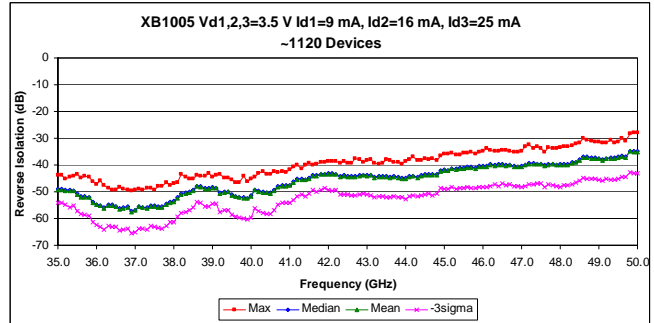
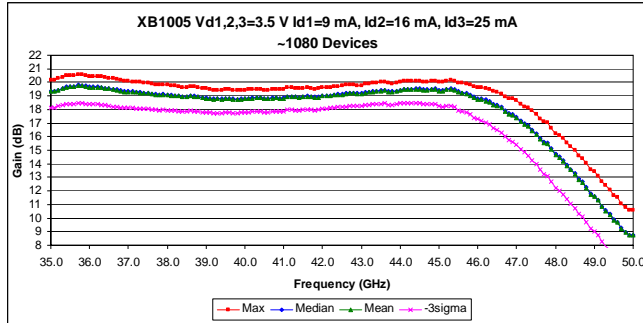
(3) Unless otherwise indicated Min/Max over 35.0-45.0 GHz and biased at Vd=4.5V, Id1=28mA, Id2=42mA, Id3=84mA.

(4) Unless otherwise indicated Min/Max over 35.0-45.0 GHz and biased at Vd=3.5V, Id1=9mA, Id2=16mA, Id3=25mA.

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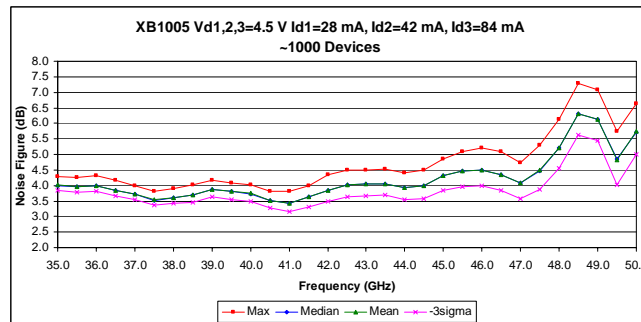
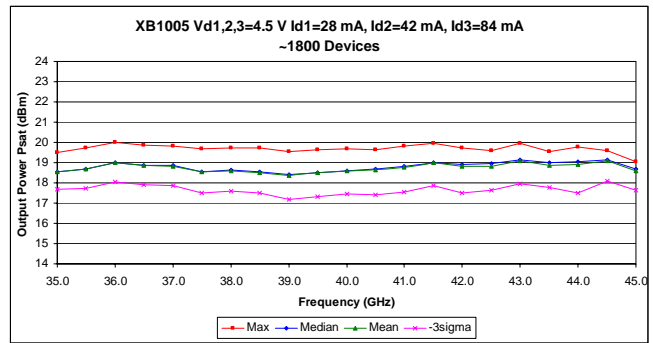
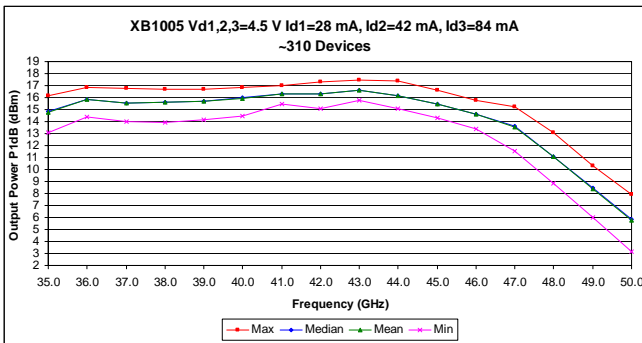
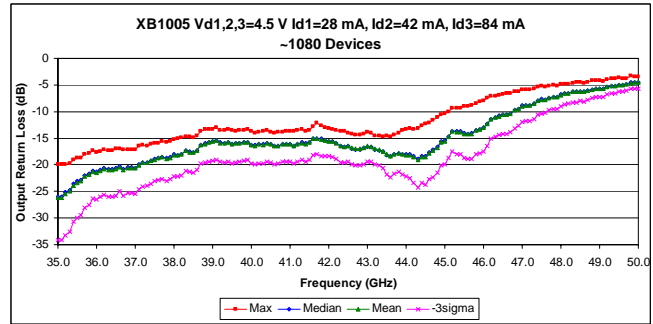
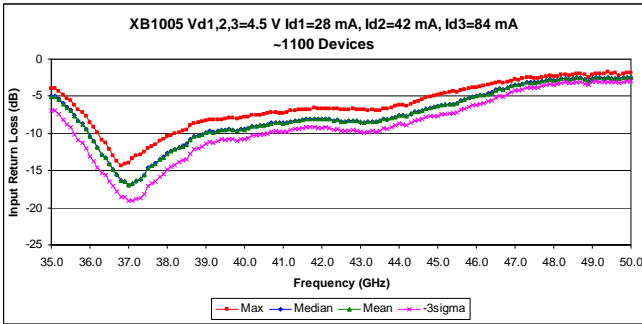
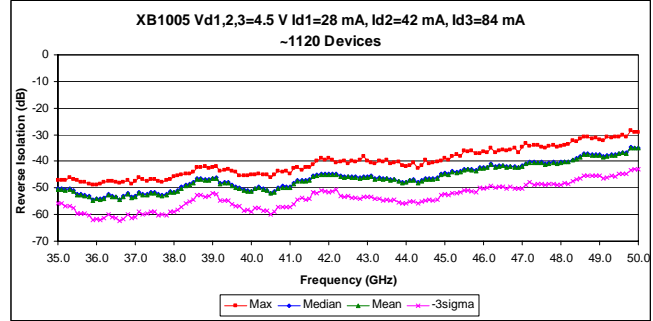
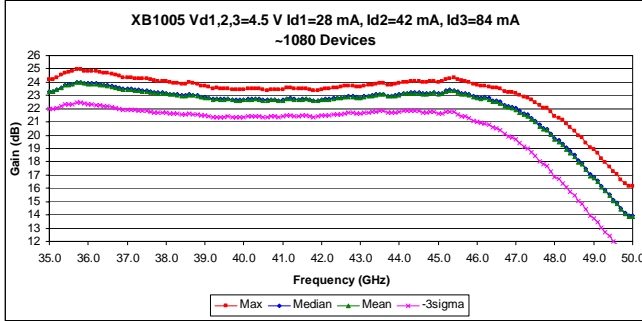
## Buffer Amplifier Measurements



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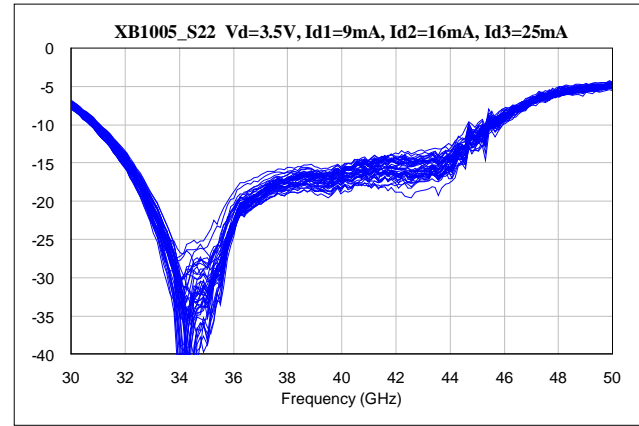
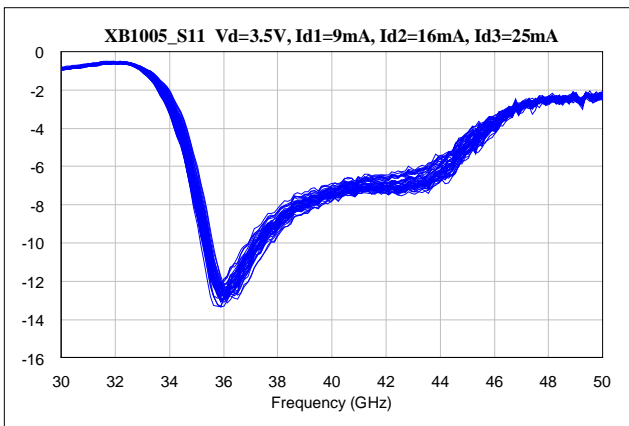
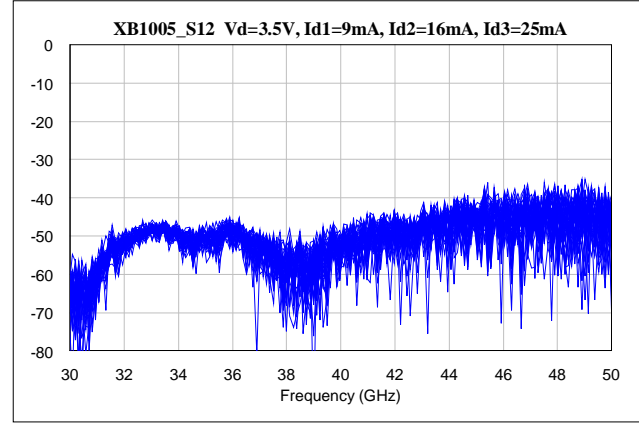
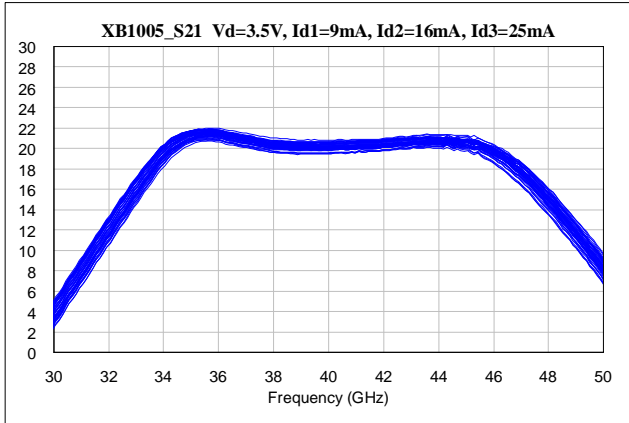
## Buffer Amplifier Measurements (cont.)



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## Buffer Amplifier Measurements (cont.)











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## S-Parameters (cont.)

Typical S-Parameter Data for XB1005 (cont'd)  
Vd=4.5 V Id1=28 mA Id2=42 mA Id3=84 mA

Frequency (GHz)	S11 Mag dB	S11 Phase Ang°	S12 Mag dB	S12 Phase Ang°	S21 Mag dB	S21 Phase Ang°	S22 Mag dB	S22 Phase Ang°
43.00	-8.466191741	63.93494	-46.01375049	41.73338	22.81158206	-104.7737	-16.49814505	-9.974573
43.10	-8.532810012	63.47232	-45.59273246	30.93189	22.89943992	-107.7251	-16.60740051	-49.54955
43.20	-8.3973384	62.41927	-46.66111736	32.53479	22.92860454	-111.2867	-17.01981045	-87.48149
43.30	-7.956498424	60.70901	-46.39034871	33.13986	22.98214357	-113.5373	-17.18763243	-112.6051
43.40	-8.437008719	58.97758	-46.8278307	33.45576	23.02877657	-117.1981	-17.49149892	-139.2157
43.50	-8.30843358	58.02209	-46.58109533	32.18636	23.0722674	-121.0676	-18.09978377	46.57008
43.60	-8.095959846	56.95599	-47.10086727	35.49992	23.06695073	-123.4921	-18.3841648	138.026
43.70	-8.105489095	55.12431	-46.92730032	38.26872	22.94948102	-127.0333	-18.00612515	121.9364
43.80	-7.95649522	53.9555	-47.6158863	34.19976	22.92697722	-130.0721	-17.77093887	86.24265
43.90	-7.771504208	52.61454	-48.00877971	35.60292	22.96084663	-132.1978	-18.05076096	59.21626
44.00	-7.493503899	49.88718	-47.95327667	36.95623	23.04149269	-135.4043	-18.13288396	23.31439
44.10	-7.579303582	47.36298	-47.28205888	40.53094	23.12761099	-138.7938	-18.10740149	-15.22874
44.20	-7.677475519	47.13729	-47.14027776	36.03515	23.14487971	-141.6755	-18.55344942	-39.1465
44.30	-7.362112151	46.71518	-48.11750772	39.2082	23.15737217	-145.8058	-19.07285459	-71.54464
44.40	-7.084036026	43.57927	-47.34567108	46.61612	23.19207951	-149.6803	-18.58186027	-103.0209
44.50	-7.01041237	42.19428	-46.82265946	49.1568	23.18841314	-152.523	-18.5581816	-126.3219
44.60	-6.90490295	40.46888	-46.66339316	52.96799	23.09860908	-155.9234	-17.84921719	-117.4898
44.70	-6.687306621	38.3066	-46.69970739	52.20012	23.11711436	-159.4528	-17.41067396	118.9883
44.80	-6.568603622	36.51917	-46.54704933	66.11798	23.14889682	-161.7395	-16.8238984	141.0049
44.90	-6.408044753	33.9311	-45.01605287	66.34527	23.19335772	-165.514	-15.84059737	108.4459
45.00	-6.353980612	32.28119	-44.67098019	54.03614	23.1161121	-169.3823	-15.57202114	72.84817
45.10	-6.17199559	30.97268	-44.93505712	51.07904	23.12717616	-170.2946	-14.78789827	50.07226
45.20	-6.115942981	27.78769	-44.17944359	47.17432	23.2789913	-167.8274	-13.74330367	8.986702
45.30	-6.043008059	25.58669	-44.25665463	42.256	23.35869995	-162.74151	-13.90788589	-29.87931
45.40	-6.017377694	23.44832	-44.08677773	42.15673	23.34949572	-165.578	-13.91357654	-53.10582
45.50	-5.919791776	23.36409	-43.36077548	34.00962	23.20551129	-169.6145	-14.20924278	-91.54504
45.60	-5.578524567	21.46825	-43.08505267	32.60976	23.12015941	-166.4463	-14.26072657	-122.0729
45.70	-5.43020021	20.00783	-43.47293989	32.68329	23.08753893	-163.6702	-14.15030921	-139.6382
45.80	-5.227056741	17.01211	-43.76607298	36.92588	23.01247327	-159.0496	-13.59895561	-47.8956
45.90	-5.0649231	14.92097	-42.69114252	36.46797	22.86117392	-154.8265	-13.38986527	142.3569
46.00	-4.977856045	14.23545	-42.64581755	34.97142	22.78261487	-152.514	-13.06321199	128.5334
46.10	-4.861647008	11.37255	-42.36742169	35.69629	22.76845193	-148.8311	-12.2873598	96.66484
46.20	-4.809729266	8.370364	-41.3968359	30.32811	22.78132313	-143.7889	-11.39217156	58.28918
46.30	-4.656190999	7.074264	-42.14098821	27.59449	22.70552256	-140.7262	-11.21100856	34.40845
46.40	-4.537576293	5.15485	-41.89109789	21.00613	22.5493722	-136.24	-10.83128251	-1.283124
46.50	-4.147107489	2.068134	-41.7446667	16.83405	22.53340376	-131.4028	-10.6445248	-36.00452
46.60	-4.018907499	-0.27889	-42.38001179	14.20166	22.42173752	-127.8261	-10.6435055	-59.1283
46.70	-4.073237724	-2.806079	-41.99072626	10.74911	22.19995815	-122.8935	-10.36266742	-91.05585
46.80	-3.806720859	-4.831432	-42.15300187	10.52681	22.11171052	-118.8167	-9.775766919	-124.4382
46.90	-3.620253764	-6.159395	-42.38817495	9.973029	22.05049856	-116.1942	-9.506493181	-143.0288
47.00	-3.42858048	-9.655697	-42.02322644	7.785538	21.93577029	-111.3829	-8.956796184	-47.87313
47.10	-3.445367386	-12.25358	-41.01781669	13.1285	21.71875513	-106.0672	-8.825092784	137.9415
47.20	-3.320606367	-13.16131	-40.43116903	8.797885	21.54780852	-103.5128	-8.799939199	120.6292
47.30	-3.115104038	-15.61146	-40.63953958	3.239813	21.43971123	-99.51881	-8.542907823	87.30853
47.40	-3.16466777	-19.4584	-40.67547203	-0.8227057	21.21285222	-94.47631	-8.004303789	53.84463
47.50	-3.165509709	-21.07638	-40.59233936	-1.921903	20.99254559	-91.02259	-7.745996347	30.17902
47.60	-3.133735135	-23.38498	-41.2734237	-0.0984054	20.67863412	-86.61945	-7.756292803	-4.936145
47.70	-3.010784707	-26.45991	-40.75545924	-7.50477	20.45322751	-82.15114	-7.456123578	-38.16262
47.80	-2.881585614	-28.34643	-40.61317082	-6.403759	20.38045077	-79.35125	-7.2376249	-59.35592
47.90	-2.772432645	-30.80593	-40.9407643	-13.2162	20.04244439	-74.67693	-7.266033965	-92.68143
48.00	-2.868742271	-33.38657	-40.56467689	-9.263591	19.66284945	-70.47761	-6.850114378	-126.6312
48.10	-2.827230211	-34.45126	-40.27609624	-5.430867	19.50040573	-67.76733	-6.6254425	-141.863
48.20	-2.642132659	-36.78955	-40.31520025	-8.518817	19.26729983	-63.61612	-6.530270985	-49.56387
48.30	-2.608161861	-39.64372	-39.64195248	-9.849635	18.94581066	-58.84941	-6.313525973	141.5602
48.40	-2.695040833	-41.36377	-39.08220503	-12.92418	18.67838598	-55.94135	-6.202247863	120.1079
48.50	-2.652836472	-43.11937	-38.47253886	-9.44034	18.39026271	-52.13172	-6.176806916	85.82643
48.60	-2.468756082	-44.2821	-37.36200157	-8.79037	17.98358514	-48.98932	-6.281051365	53.61549
48.70	-2.515583517	-47.1987	-37.37192489	-12.42549	17.8031175	-45.22096	-6.121823887	32.30106
48.80	-2.712477122	-49.4547	-37.72641836	-16.98318	17.40429895	-40.89746	-5.855151202	-1.816883
48.90	-2.922953111	-50.96608	-37.70207636	-12.23584	16.93570979	-37.64836	-5.689345329	-35.08606
49.00	-2.615840867	-53.0897	-37.81972708	-13.90446	16.78142681	-34.65386	-5.72842207	-57.12588
49.10	-2.44668787	-54.70441	-38.34801661	-23.30115	16.50404293	-31.30288	-5.73703444	-90.52146
49.20	-2.50096114	-55.83318	-38.06681878	-31.237	16.08267577	-27.09127	-5.296762657	-122.6663
49.30	-2.567746873	-56.57803	-37.62001934	-29.55196	15.77792003	-25.20954	-5.13062705	-143.8559
49.40	-2.509356278	-59.15225	-37.72079215	-19.6743	15.45852985	-22.15488	-5.224764603	-51.1178
49.50	-2.599529494	-61.19781	-37.24983239	-20.91034	15.04709833	-18.61195	-4.983526698	140.9411
49.60	-2.558497569	-62.7948	-36.83574058	-23.78484	14.8456312	-16.07037	-4.981221921	126.1345
49.70	-2.6550585	-64.86092	-37.0079248	-22.62072	14.40611894	-12.14211	-4.908845652	93.7889
49.80	-2.509700169	-65.71354	-35.16219098	-15.76751	14.11064988	-8.821751	-4.592613571	60.47185
49.90	-2.449882181	-66.52166	-35.14038168	-13.62498	13.89820763	-6.90788	-4.583266784	38.67072
50.00	-2.449882181	-66.52166	-35.14038168	-13.62498	13.89820763	-6.90788	-4.583266784	38.67072

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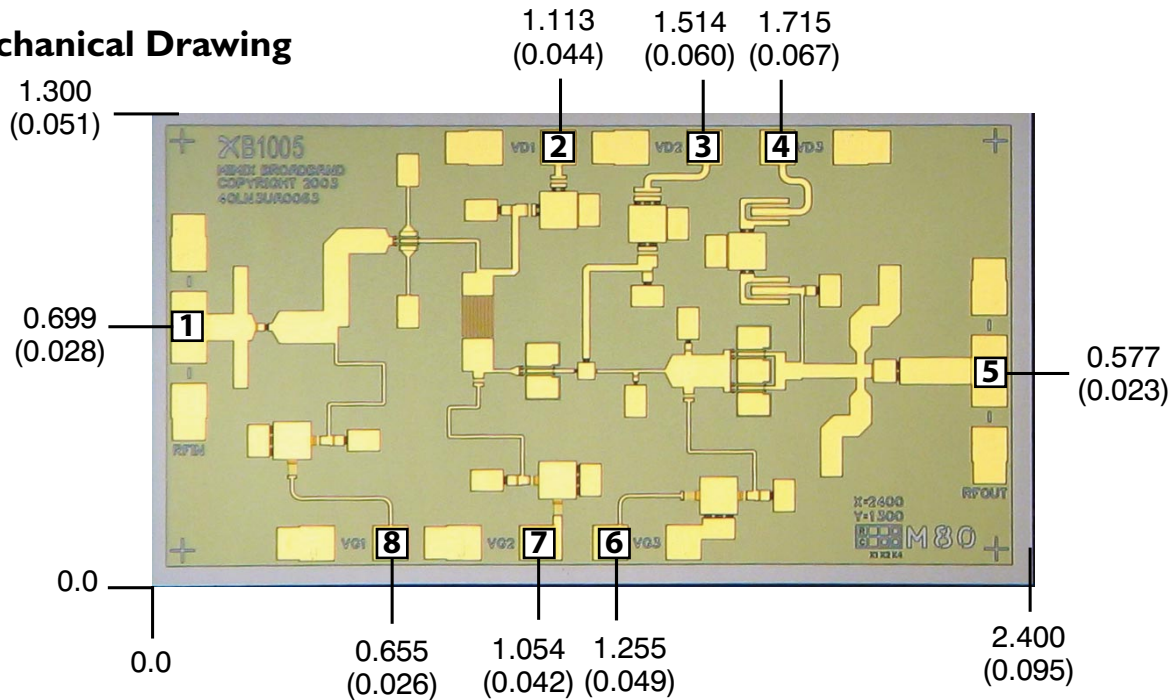
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## Mechanical Drawing

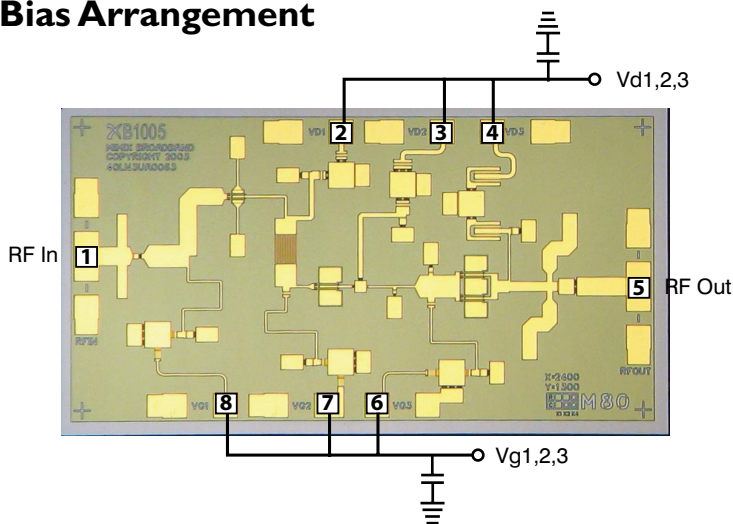


(Note: Engineering designator is 40LN3UA0063)

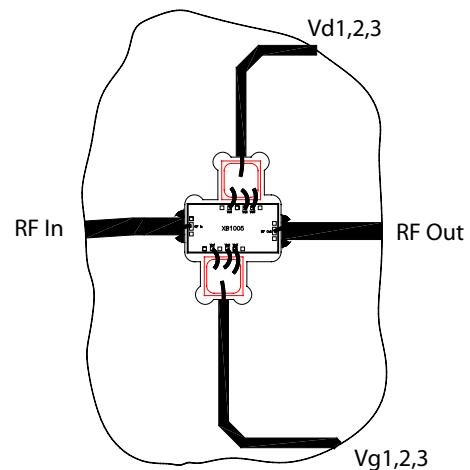
Units: millimeters (inches) Bond pad dimensions are shown to center of bond pad.  
 Thickness: 0.110 +/- 0.010 (0.0043 +/- 0.0004), Backside is ground, Bond Pad/Backside Metallization: Gold  
 All DC Bond Pads are 0.100 x 0.100 (0.004 x 0.004). All RF Bond Pads are 0.100 x 0.200 (0.004 x 0.008)  
 Bond pad centers are approximately 0.109 (0.004) from the edge of the chip.  
 Dicing tolerance: +/- 0.005 (+/- 0.0002). Approximate weight: 1.931 mg.

Bond Pad #1 (RF In)	Bond Pad #3 (Vd2)	Bond Pad #5 (RF Out)	Bond Pad #7 (Vg2)
Bond Pad #2 (Vd1)	Bond Pad #4 (Vd3)	Bond Pad #6 (Vg3)	Bond Pad #8 (Vg1)

## Bias Arrangement



Bypass Capacitors - See App Note [2]



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**App Note [1] Biasing** - As shown in the bonding diagram, this device can be operated with all three stages in parallel, and can be biased for low noise performance or high power performance. Low noise bias is nominally  $V_d=3.5V, I_d=50mA$ . More controlled performance will be obtained by separately biasing  $V_{d1}, V_{d2}$  and  $V_{d3}$  each at 3.5V, with  $I_{d1}=9mA, I_{d2}=16mA, I_{d3}=25mA$ . Power bias may be as high as  $V_d=4.5V, I_d=154mA$  with all stages in parallel, or most controlled performance will be obtained by separately biasing  $V_{d1}, V_{d2}$  and  $V_{d3}$  each at 4.5V, with  $I_{d1}=28mA, I_{d2}=42mA, I_{d3}=84mA$ . It is also recommended to use active biasing to keep the currents constant as the RF power and temperature vary; this gives the most reproducible results. Depending on the supply voltage available and the power dissipation constraints, the bias circuit may be a single transistor or a low power operational amplifier, with a low value resistor in series with the drain supply used to sense the current. The gate of the pHEMT is controlled to maintain correct drain current and thus drain voltage. The typical gate voltage needed to do this is -0.4V. Typically the gate is protected with Silicon diodes to limit the applied voltage. Also, make sure to sequence the applied voltage to ensure negative gate bias is available before applying the positive drain supply.

## App Note [2] Bias Arrangement -

For Parallel Stage Bias (Recommended for general applications) -- The same as Individual Stage Bias but all the drain or gate pad DC bypass capacitors (~100-200 pf) can be combined. Additional DC bypass capacitance (~0.01 uF) is also recommended to all DC or combination (if gate or drains are tied together) of DC bias pads.

For Individual Stage Bias (Recommended for Saturated Applications) -- Each DC pad ( $V_{d1,2,3}$  and  $V_{g1,2,3}$ ) needs to have DC bypass capacitance (~100-200 pf) as close to the device as possible. Additional DC bypass capacitance (~0.01 uF) is also recommended.

## MTTF Table

These numbers were calculated based on accelerated life test information and thermal model analysis received from the fabricating foundry.

Backplate Temperature	Channel Temperature	Rth	MTTF Hours	FITs
55 deg Celsius	82.9 deg Celsius	159.3° C/W	8.36E+10	1.20E-02
75 deg Celsius	105.0 deg Celsius	171.3° C/W	5.38E+09	1.86E-01
95 deg Celsius	126.8 deg Celsius	182.0° C/W	4.79E+08	2.09E+00

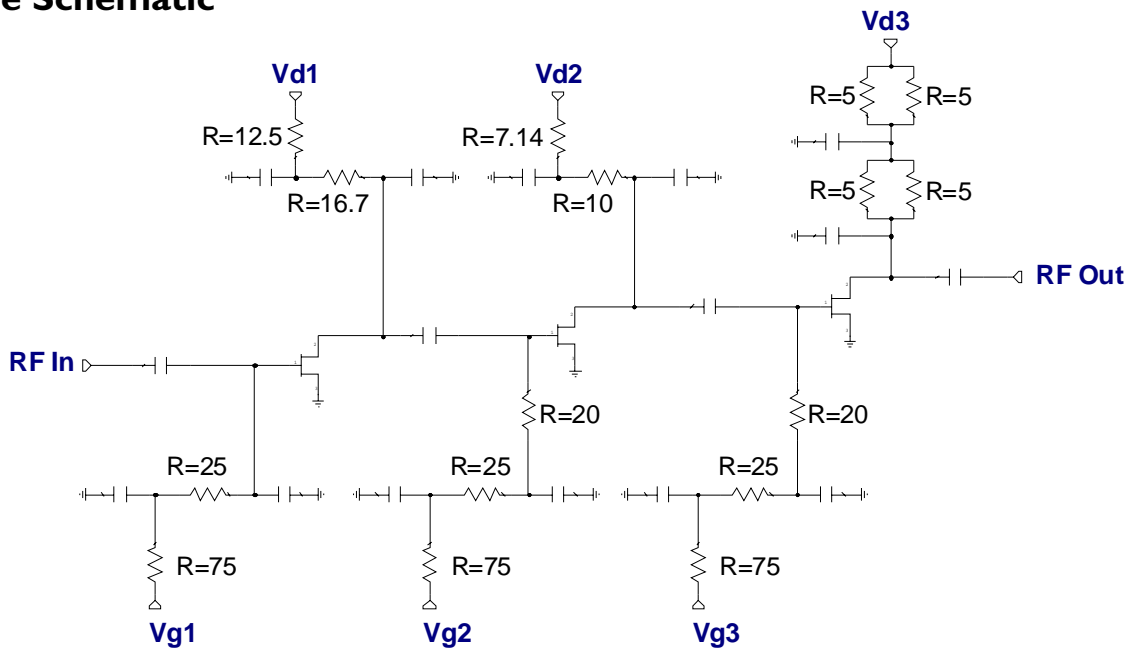
**Bias Conditions:**  $V_{d1}=V_{d2}=V_{d3}=3.5V, I_{d1}=9mA, I_{d2}=16mA, I_{d3}=25mA$

Backplate Temperature	Channel Temperature	Rth	MTTF Hours	FITs
55 deg Celsius	157.3 deg Celsius	147.6° C/W	3.00E+07	3.34E+01
75 deg Celsius	184.0 deg Celsius	157.3° C/W	3.07E+06	3.26E+02
95 deg Celsius	210.1 deg Celsius	166.1° C/W	4.21E+05	2.37E+03

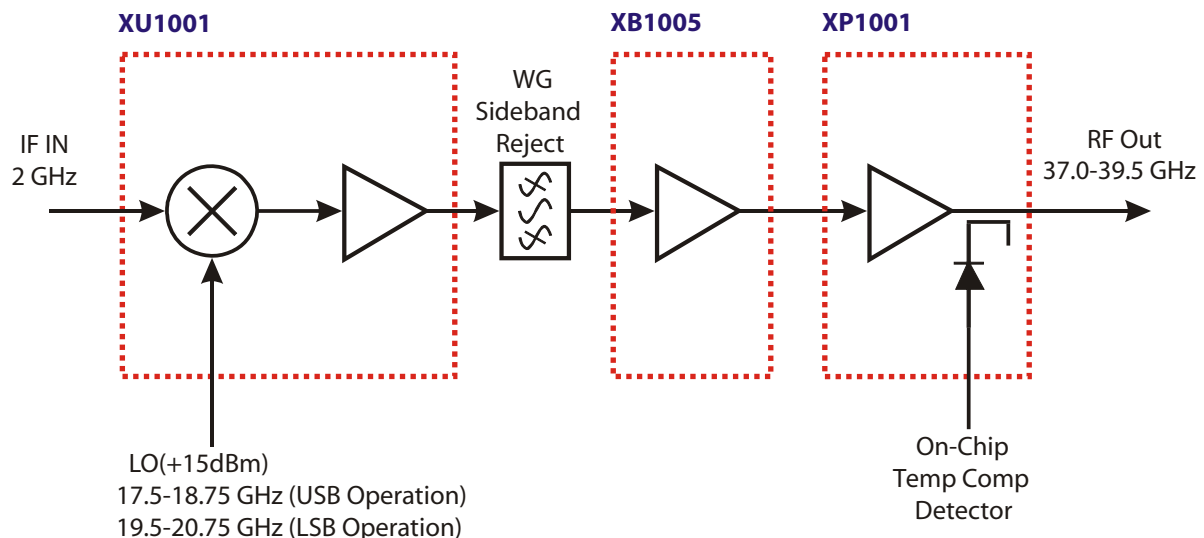
**Bias Conditions:**  $V_{d1}=V_{d2}=V_{d3}=4.5V, I_{d1}=28mA, I_{d2}=42mA, I_{d3}=84mA$

# 35.0-45.0 GHz GaAs MMIC Buffer Amplifier

## Device Schematic



## Typical Application



### Mimix Broadband MMIC-based 36.0-40.0 GHz Transmitter Block Diagram

(Changing LO and IF frequencies as required allows design to operate as high as 40 GHz)

# 35.0-45.0 GHz GaAs MMIC Buffer Amplifier

March 2007 - Rev 06-Mar-07

## Handling and Assembly Information

**CAUTION!** - Mimix Broadband MMIC Products contain gallium arsenide (GaAs) which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- *Do not ingest.*
- *Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.*
- *Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.*

**Life Support Policy** - Mimix Broadband's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President and General Counsel of Mimix Broadband. As used herein: (1) Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user. (2) A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

**ESD** - Gallium Arsenide (GaAs) devices are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic containers, which should be opened in cleanroom conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickups or, with care, sharp tweezers.

**Die Attachment** - GaAs Products from Mimix Broadband are 0.100 mm (0.004") thick and have vias through to the backside to enable grounding to the circuit. Microstrip substrates should be brought as close to the die as possible. The mounting surface should be clean and flat. If using conductive epoxy, recommended epoxies are Tanaka TS3332LD, Die Mat DM6030HK or DM6030HK-Pt cured in a nitrogen atmosphere per manufacturer's cure schedule. Apply epoxy sparingly to avoid getting any on to the top surface of the die. An epoxy fillet should be visible around the total die periphery. For additional information please see the Mimix "Epoxy Specifications for Bare Die" application note. If eutectic mounting is preferred, then a fluxless gold-tin (AuSn) preform, approximately 0.001 thick, placed between the die and the attachment surface should be used. A die bonder that utilizes a heated collet and provides scrubbing action to ensure total wetting to prevent void formation in a nitrogen atmosphere is recommended. The gold-tin eutectic (80% Au 20% Sn) has a melting point of approximately 280 °C (Note: Gold Germanium should be avoided). The work station temperature should be 310 °C +/- 10 °C. Exposure to these extreme temperatures should be kept to minimum. The collet should be heated, and the die pre-heated to avoid excessive thermal shock. Avoidance of air bridges and force impact are critical during placement.

**Wire Bonding** - Windows in the surface passivation above the bond pads are provided to allow wire bonding to the die's gold bond pads. The recommended wire bonding procedure uses 0.076 mm x 0.013 mm (0.003" x 0.0005") 99.99% pure gold ribbon with 0.5-2% elongation to minimize RF port bond inductance. Gold 0.025 mm (0.001") diameter wedge or ball bonds are acceptable for DC Bias connections. Aluminum wire should be avoided. Thermo-compression bonding is recommended though thermosonic bonding may be used providing the ultrasonic content of the bond is minimized. Bond force, time and ultrasonics are all critical parameters. Bonds should be made from the bond pads on the die to the package or substrate. All bonds should be as short as possible.

Part Number for Ordering	Description
XB1005-BD-000V	Where "V" is RoHS compliant die packed in vacuum release gel paks
XB1005-BD-EV1	XB1005 die evaluation module